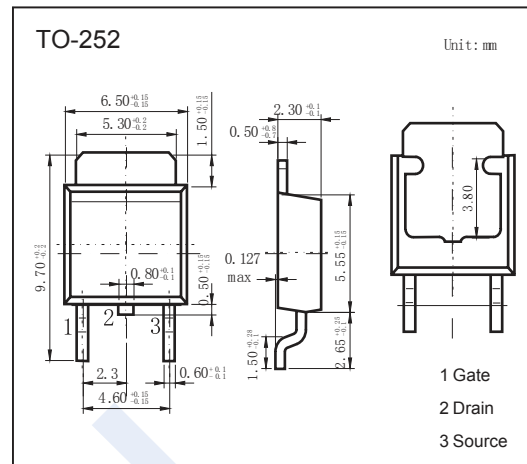
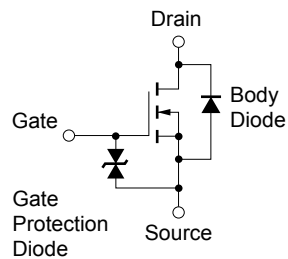


N-Channel MOSFET

2SK3224-Z

■ Features

- $V_{DS} (V) = 60V$
- $I_D = 20 A (V_{GS} = 10V)$
- $R_{DS(ON)} < 40m\Omega (V_{GS} = 10V)$
- $R_{DS(ON)} < 60m\Omega (V_{GS} = 4V)$
- Low Ciss : Ciss = 790 pF TYP.



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage (AC)	V_{GS}	± 20	
		+20,-10	
Continuous Drain Current	I_D	20	A
Pulsed Drain Current (Note.1)	I_{DM}	70	
Single Avalanche Current (Note.2)	I_{AS}	10	
Power Dissipation $T_c = 25^\circ C$ $T_a = 25^\circ C$	P_D	25	W
		1	
Single Avalanche Energy (Note.2)	E_{AS}	10	mJ
Thermal Resistance.Junction- to-Ambient	R_{thJA}	125	$^\circ C/W$
Thermal Resistance.Junction- to-Case	R_{thJC}	5	
Junction Temperature	T_J	150	$^\circ C$
Storage Temperature Range	T_{stg}	-55 to 150	

Note.1: $PW \leq 10 \mu s$, Duty cycle $\leq 1\%$

Note.2: Starting $T_J = 25^\circ C$, $R_G = 25\Omega$, $V_{GS} = 20V - 0V$

N-Channel MOSFET

2SK3224-Z

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =250 μ A, V _{GS} =0V	60			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V			10	μ A
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} = $\pm$ 20V			$\pm$ 10	μ A
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} =10V, I _D =1mA	1		2	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A			40	m Ω
		V _{GS} =4V, I _D =10A			60	
Forward Transconductance	g _{FS}	V _{GS} =10V, I _D =10A	8	15		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =10V, f=1MHz		790		pF
Output Capacitance	C _{oss}			240		
Reverse Transfer Capacitance	C _{rss}			100		
Total Gate Charge	Q _g	V _{GS(on)} =10V, V _{DS} =48V, I _D =20A		20		nC
Gate Source Charge	Q _{gs}			3		
Gate Drain Charge	Q _{gd}			6.5		
Turn-On DelayTime	t _{d(on)}	V _{GS(on)} =10V, V _{DS} =30V, I _D =10A, R _G =10 Ω		19		ns
Turn-On Rise Time	t _r			165		
Turn-Off DelayTime	t _{d(off)}			62		
Turn-Off Fall Time	t _f			71		
Body Diode Reverse Recovery Time	t _{rr}	I _F =20A, V _{GS} =0V, di/dt=100A/ μ s		40		nC
Body Diode Reverse Recovery Charge	Q _{rr}			45		
Diode Forward Voltage	V _{SD}	I _F =20A, V _{GS} =0V		0.93		V